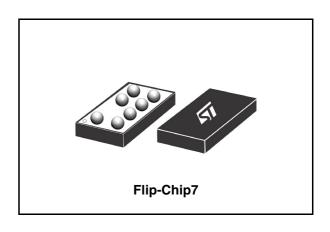


STG4159

Low voltage 0.3Ω max single SPDT switch with break-before-make feature and 10kV contact ESD protection

Features

- Wide operating voltage range: V_{CC} (OPR) = 1.65V to 4.8V
- Low power dissipation: $I_{CC} = 0.2\mu A \text{ (max.)}$ at $T_A = 85^{\circ}C$
- Low "ON" resistance V_{IN} = 0V:
 - R_{ON} = 0.40Ω (max. T_A = 25°C) at V_{CC} = 2.25V
 - R_{ON} = 0.35 Ω (max. T_A = 25 $^{\circ}$ C) at V_{CC} = 3.0V
 - R_{ON} = 0.30 Ω (max. T_A = 25 $^{\circ}$ C) at V_{CC} = 4.3V
- Separate supply voltage for switch and control pin
- Latch-up performance exceeds 100mA per JESD 78, Class II
- ESD performance tested on common channel (D pin)
 - 10kV IEC-61000-4-2 ESD, contact discharge
 - 15kV IEC-61000-4-2 ESD, air discharge
- ESD performance test on all other pins
 - 10kV IEC-61000-4-2 ESD, contact discharge
 - 500V machine model (JESD22 A115-A)
 - 1500V charged-device model (JESD22 C101)



Description

The STG4159 is a high-speed CMOS low voltage single analog SPDT (Single Pole Dual Throw) switch or 2:1 multiplexer/demultiplexer switch fabricated in silicon gate C^2 MOS technology. It is designed to operate from 1.65V to 4.58V, making this device ideal for portable applications. It offers low ON-resistance (0.45 Ω) at V_{CC} = 4.3V. The SEL inputs are provided to control the switches.

The switch S1 is ON (connected to common Port D) when the SEL input is held high and OFF (high impedance state exists between the two ports) when SEL is held low; the switch S2 is ON (it is connected to common Port D) when the SEL input is held low and OFF (high impedance state exist between the two ports) when SEL is held high.

Additional key features are fast switching speed, break-before-make delay time and ultra low power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Table 1. Device summary

Part number	Package	Packaging
STG4159	Flip-Chip7	Tube
STG4159BJR	Flip-Chip7	Tape and reel

Contents STG4159

Contents

1	Logic diagram	3
2	Maximum rating	5
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STG4159 Logic diagram

1 Logic diagram

Figure 1. Functional diagram

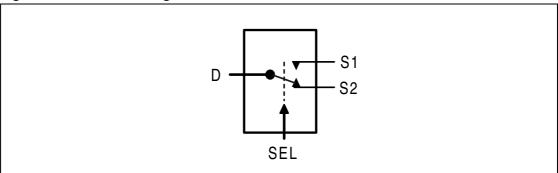


Figure 2. Input equivalent circuit

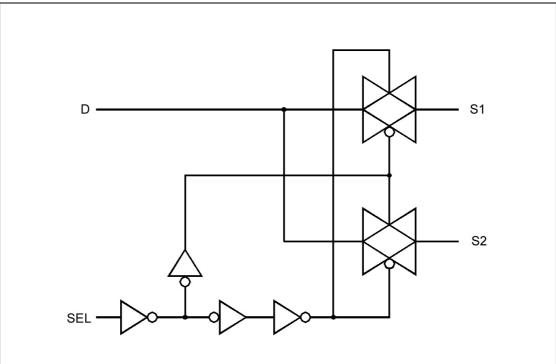


Table 2. Truth table

SEL	Switch S1	Switch S2
Н	ON	OFF ⁽¹⁾
L	OFF ⁽¹⁾	ON

^{1.} High Impedance

Logic diagram STG4159

Figure 3. Pin connection (bump side view)

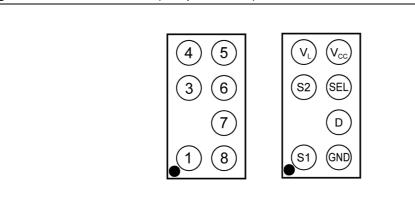


Table 3. Pin description

	1	
Flip-Chip	Symbol	Name and function
1, 3	S1, S2	Independent channels
7	D	Common channel
6	SEL	Control
5	V _{CC}	Positive supply voltage
4	V _L	Logic supply voltage
8	GND	Ground (0V)

STG4159 Maximum rating

2 Maximum rating

Stressing the device above the rating listed in the "Absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 4. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to 5.5	٧
V _L	Logic supply voltage	-0.5 to 5.5	V
V _I	DC input voltage	-0.5 to V _{CC} + 0.5	V
V _{IC}	DC control input voltage	-0.5 to V _L + 0.5	V
V _O	DC output voltage	-0.5 to V _{CC} + 0.5	V
I _{IKC}	DC input diode current on control pin (V _{SEL} < 0V)	-50	mA
I _{IK}	DC input diode current (V _{SEL} < 0V)	±50	mA
I _{OK}	DC output diode current	±20	mA
Io	DC output current	±300	mA
I _{OP}	DC output current peak (pulse at 1ms, 10% duty cycle)	±500	mA
I _{CC} or I _{GND}	DC V _{CC} or ground current	±100	mA
P _D	Power dissipation at T _A = 70°C ⁽¹⁾	500	mW
T _{stg}	Storage temperature	-50 to 105	°C
T _L	Lead temperature (10 sec)	260	°C

^{1.} Derate above 70°C by 18.5mW/C

Table 5. Recommended operating conditions

	- 1100011111111111111111111111111111111						
Symbol	Parameter		Value	Unit			
V _{CC}	Supply voltage (1)		1.65 to 4.8	V			
V_{L}	Logic supply voltage (2)		1.65 to V _{CC}	V			
V _I	Input voltage		0 to V _{CC}	V			
V _{IC}	Control input voltage		0 to V _L	V			
V _O	Output voltage		0 to V _{CC}	V			
T _{op}	Operating temperature	-40 to 85	°C				
dt/dv	Input rise and fall time control input	V _L = 1.65V to 2.7V	0 to 20	ns/V			
GI/UV	Imput rise and fair time control imput	0 to 10	115/V				

^{1.} Truth Table guaranteed: 1.65V to 4.8V

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^{2.} V_L pin should not be left floating.

Electrical characteristics STG4159

3 Electrical characteristics

Table 6. DC specifications

			Test condi	tions			Value			
Symbol	Parameter	V (V)	V (V)		T,	_A = 25°	°C	-40 to	85°C	Unit
		V _{CC} (V)	V _L (V)		Min.	Тур.	Max.	Min.	Max.	-
			1.65-1.95		1.25			1.25		
V	High level input	1.65-4.3	2.3-2.7		1.75			1.75		V
V_{IH}	voltage	1.65-4.3	3.0-3.6		2.35			2.35		V
			4.3		2.8			2.8		
			1.65-1.95				0.6		0.6	
V_{IL}	Low level input	1.65-4.3	2.3-2.7				0.8		0.8	V
۷IL	voltage	1.65-4.3	3.0-3.6				1.05		1.05	V
			4.3				1.5		1.5	
		1.8				0.49	0.65		0.85	
		2.25		\/ O\/ += \/		0.30	0.40		0.50	Ω
R_{ON}	R _{ON} ON resistance	3	1.65-4.3	1.65-4.3 $V_S=0V \text{ to } V_{CC}$ $I_S=100\text{mA}$		0.25	0.35		0.45	
		3.7				0.22	0.32		0.42	
		4.3				0.21	0.30		0.40	
		1.8				5				
	ON resistance	2.25	1.65-4.3	\/_0\/+c\/		3				
ΔR_{ON}	match between	3		V_S =0V to V_{CC} I_S =100mA		3				mΩ
	channels ⁽¹⁾	3.7		ig=100mA		3				
		4.3				3				1
		1.8				300	400		450	
	ONI was is to was	2.5		\/ -0\/ to \/ -		130	170		230	
R_{FLAT}	ON resistance flatness (2)	3	1.65 - 4.3	V_S =0V to V_{CC} I_S =100mA		90	120		170	mΩ
	natrices	3.7		15-10011111		90	120		170	
		4.3				90	120		170	
I _{OFF}	Sn OFF state leakage current	1.65-4.3	1.65 - 4.3	$V_S=0$ to V_{CC} $V_D=0$ to V_{CC}	-20		20	-300	300	nA
I _{ON}	Sn ON state leakage current	1.65-4.3	1.65 - 4.3	V _S =0 to V _{CC} V _D =Open	-20		20	-100	100	nA
I _D	D ON state leakage current	1.65-4.3	1.65 - 4.3	V _S =Open V _D =0 to V _{CC}	-20		20	-100	100	nA

Table 6. DC specifications

	•									
			Test conditions							
Symbol	Parameter	V _{CC} (V) V _L (V)			T _A = 25°C		-40 to 85°C		Unit	
					Min.	Тур.	Max.	Min.	Max.	
I _{CC}	Quiescent supply current			V _{SEL} =V _{CC} or GND			0.05	-0.2	0.2	μА
I _{SEL}	SEL leakage current	1.65-4.3	1.65 - 4.3	V _{SEL} =4.3V or GND	-0.1		0.1	-1	1	μА

^{1.} $\Delta R_{ON} = R_{ON(Max)} - R_{ON(Min)}$

Table 7. AC electrical characteristics ($C_L = 35pF, R_L = 50\Omega, t_r = t_f \le 5ns$)

			Test conditions			Value																		
Symbol	Parameter	V _{CC} (V)	V _L (V)		Т	_A = 25°	С	-40 to	85°C	Unit														
		VCC (V)	VL(V)		Min.	Тур.	Max.	Min.	Max.															
		1.65-1.95				0.13																		
t _{PLH} ,	Propagation	2.3-2.7	1.65-4.3			0.15				ns														
t _{PHL}	delay	3.0-3.3	1.05-4.5			0.16				115														
		3.6-4.3				0.16																		
		1.65-1.95		V V		95	123		160															
t _{ON}	TURN-ON	2.3-2.7	165 / 2	$V_S = V_{CC}$ $R_1 = 500$		48	62		80	ns														
ON	time	3-3.6	1.65-4.3	$C_1 = 30pF$		33	43		56	115														
		4.3								29	38		49											
		1.65-1.95	1.65-4.3	V V		12	15		20															
t _{OFF}	TURN-OFF	2.3-2.7		1.65-4.3	1.65-4.3	1.65-4.3	1.65-4.3	1.65-4.3	1.65-4.3	$V_S = V_{CC}$		12	16		21	ns								
OFF	time	3-3.6																$C_1 = 30pF$		13	17		22	113
		4.3										13	17		22									
		1.65-1.95		0.05=5	10	42																		
t _D	Break- before-make	2.3-2.7	1 05 4 0	165 40	$C_L = 35pF$ $R_L = 50\Omega$	10	22				ns													
טי	time delay	3-3.6	1.05-4.5	$V_S = V_{CC}/2$	5	15				113														
		4.3		0 00	5	12																		
		1.65-1.95				83																		
0	Q Charge injection	2.3-2.7	1 65-4 3	$C_L = 1nF$ $V_{GEN} = 0V$		98				рС														
_ ~		3.0-3.3	1.00-4.0	$V_{GEN} = 0V$		114																		
		3.6-4.3				140																		

^{2.} Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

Electrical characteristics STG4159

Table 8. Analog switch characteristics ($C_L = 5pF$, $R_L = 50\Omega$, $T_A = 25^{\circ}C$)

		,	Test cond	ditions			Value			
Symbol	Parameter	V _{CC} (V)	V _L (V)		T,	_A = 25°	С	-40 to	85°C	Unit
		CC ()	V L (V)		Min.	Тур.	Max.	Min.	Max.	
OIRR	Off Isolation	1.65-4.3	4.3	$V_S = 1V_{RMS}$ f = 100kHz		-69				dB
Xtalk	Crosstalk	1.65-4.3	4.3	$V_S = 1V_{RMS}$ f = 100kHz		-69				dB
THD	Total harmonic distortion	2.3-4.3	4.3	$R_{L} = 600\Omega$ $C_{L} = 50pF$ $V_{S} = V_{CC} V_{PP}$ $f = 600Hz \text{ to}$ $20kHz$		0.01				%
BW	-3dB Bandwidth (switch ON)	1.65-4.3	4.3	R _L = 50Ω		28				MHz
C _{SEL}	Control pin input capacitance	1.8-4.3	1.8-4.3	V _L = V _{CC}		30				
C _{Sn}	Sn port capacitance	1.8-4.3	1.8-4.3	$V_L = V_{CC}$		94				pF
C _D	D port capacitance when switch is enabled	1.8-4.3	1.8-4.3	$V_L = V_{CC}$		227				

^{1.} OFF-isolation = 20 log_{10} (VD/VS), V_D = output, V_S = input to off switch

STG4159 Test circuits

4 Test circuits

Figure 4. ON-Resistance

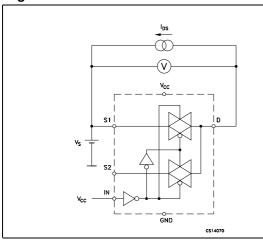


Figure 5. Bandwidth

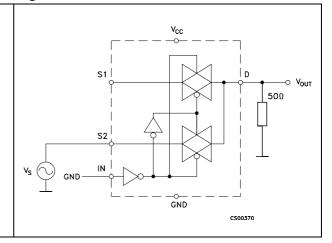


Figure 6. OFF Leakage

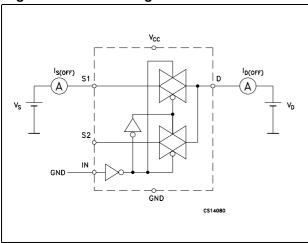


Figure 7. Channel to channel crosstalk

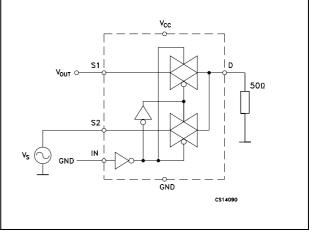
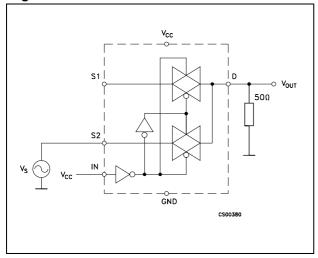
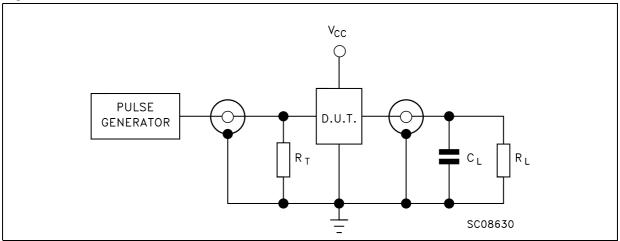


Figure 8. OFF Isolation



Test circuits STG4159

Figure 9. Test circuit

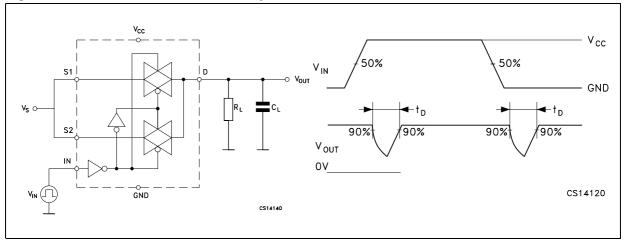


Note: 1 $C_L = 5/35$ pF or equivalent: (includes jig capacitance)

2 $R_L = 50\Omega$ or equivalent

3 $R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 10. Break-before-make time delay



STG4159 Test circuits

Figure 11. Switching time and charge injection

 $(V_{GEN} = 0V, R_{GEN} = 0\Omega, R_{L} = 1M\Omega, C_{L} = 100pF)$

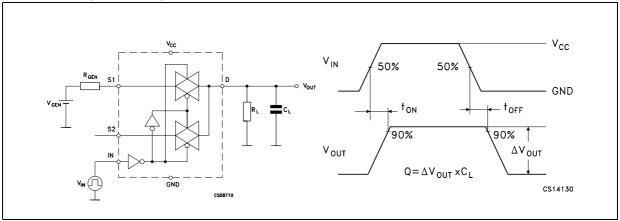
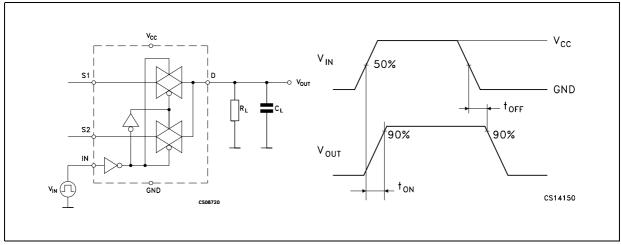


Figure 12. Turn ON, turn OFF delay time



5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Table 9. Flip-Chip7 mechanical data

Dim.		Data book (mm)		Drawing (mm)	
Dim.	Min	Тур	Max	Min	Тур	Max
Α	0.585	0.65	0.715	0.60	0.65	0.70
A1	0.21	0.25	0.29	0.22	0.25	0.28
A2		0.4		0.38	0.4	0.42
b	0.265	0.315	0.365	0.290	0.315	0.340
D	1.018	1.068	1.118	1.053	1.068	1.083
D1		0.5		0.49	0.5	0.51
E	2.018	2.068	2.118	2.053	2.068	2.083
E1		1.5		1.49	1.5	1.51
е	0.45	0.5	0.55	0.46	0.5	0.54
f		0.284		0.272	0.284	0.292
ccc		0.08			0.08	

Note: 1 The terminal Pin 1 on the bumps side is identified by a distinguishing feature (for instance by a circular "clear area" - typically 0.1mm diameter -) The terminal Pin 1 on the backside of the product is identified by a distinguishing feature (for instance by a circular "dot" - typically 0.5mm diameter -).

Figure 13. Package dimensions

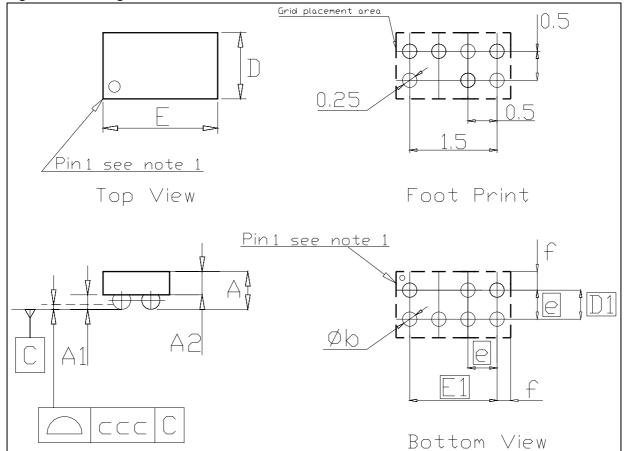


Figure 14. Foot print recommendations

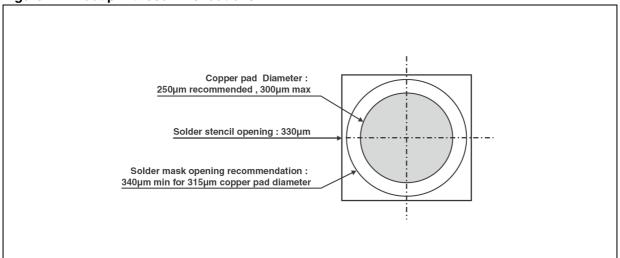


Figure 15. Marking

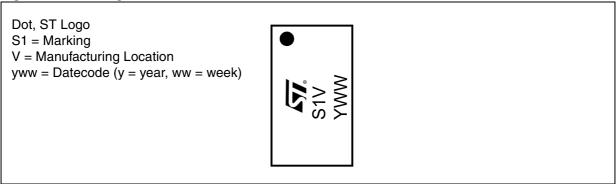
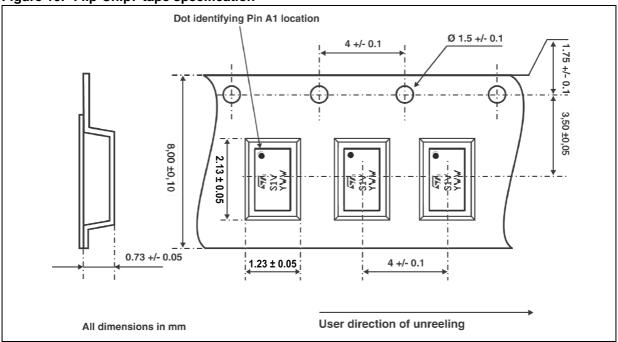


Figure 16. Flip-Chip7 tape specification



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Figure 17. Flip-Chip7 reel information

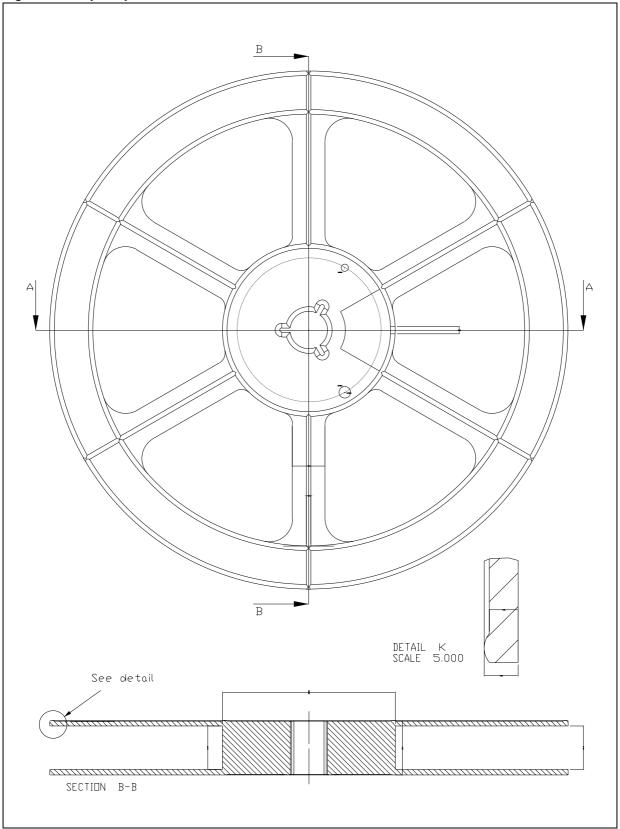
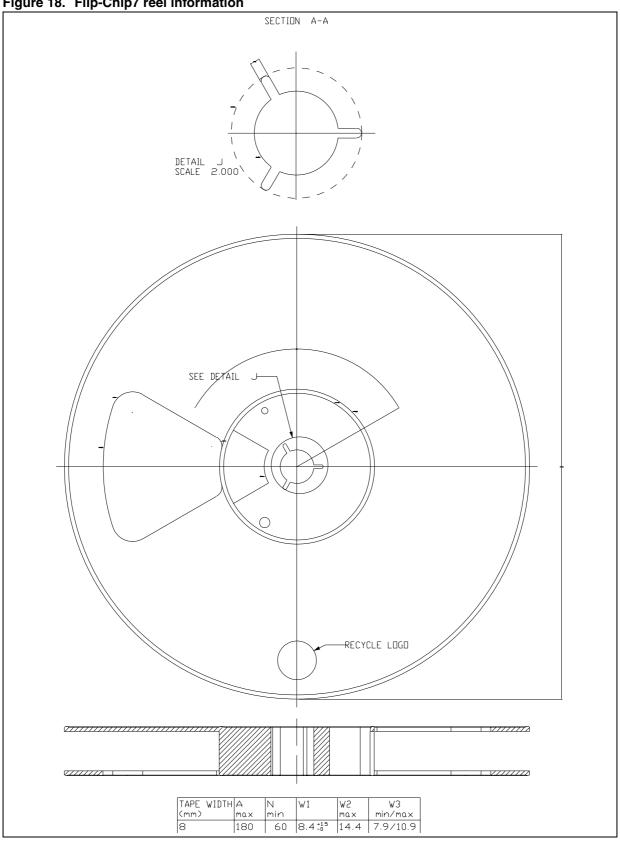


Figure 18. Flip-Chip7 reel information



STG4159 Revision history

6 Revision history

Table 10. Revision history

Date	Revision	Changes			
05-May-2006	1	First release			
22-Nov-2006	2	Schematic Figure 1 on page 3 updated			
17-Apr-2007	3	Typo in cover page description			

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